

STGW35NC120HD

32 A, 1200 V very fast IGBT

Datasheet - production data

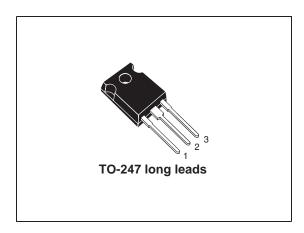
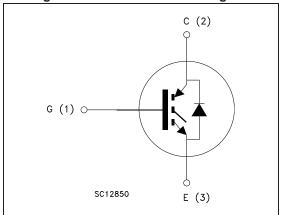


Figure 1. Internal schematic diagram



Features

- Low on-losses
- Low on-voltage drop (V_{CE(sat)})
- High current capability
- IGBT co-packaged with ultrafast free-wheeling diode
- Low gate charge
- Ideal for soft switching application

Application

- Induction heating
- High frequency inverters
- UPS

Description

This IGBT utilizes the advanced PowerMESH™ process resulting in an excellent trade-off between switching performance and low on-state behavior.

Table 1. Device summary

Order code	Marking	Package	Packaging
STGW35NC120HD	STGW35NC120HD GW35NC120HD		Tube

Contents STGW35NC120HD

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STGW35NC120HD Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	1200	V
I _C ⁽¹⁾	Continuous collector current at T _C = 25 °C	60	Α
I _C ⁽¹⁾	Continuous collector current at T _C = 100 °C	32	Α
I _{CL} (2)	Turn-off latching current	135	Α
I _{CP} (3)	Pulsed collector current	135	Α
V _{GE}	Gate-emitter voltage	±25	٧
P _{TOT}	Total dissipation at T _C = 25 °C	235	W
I _F	Diode RMS forward current at T _C = 25 °C	30	Α
I _{FSM}	Surge non repetitive forward current t _p = 10 ms sinusoidal	100	Α
T _j	Operating junction temperature	-55 to 150	°C

1. Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2. Vclamp = 80% of V_{CES}, T_j =125 °C, R_G=10 Ω , V_{GE}=15 V
- 3. Pulse width limited by max. junction temperature allowed

Table 3. Thermal data

Symbol	Parameter	Value	Unit
ь	Thermal resistance junction-case IGBT	0.53	°C/W
R _{thj-case}	Thermal resistance junction-case diode	1.5	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	50	°C/W

Electrical characteristics STGW35NC120HD

2 Electrical characteristics

(T_i =25 °C unless otherwise specified)

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	1200			V
V _{CE(sat)}	Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 20 A, V _{GE} = 15 V, I _C = 20 A, T _j =125 °C		2.2 2.0	2.75	V V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}, I_{C} = 250 \mu A$	3.75		5.75	V
I _{CES}	Collector cut-off current (V _{GE} = 0)	V _{CE} =1200 V V _{CE} =1200 V, T _j =125 °C			500 10	μA mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} =± 20 V			± 100	nA
9fs ⁽¹⁾	Forward transconductance	V _{CE} = 25 V _, I _C = 20 A		14		S

^{1.} Pulse duration = 300 μ s, duty cycle 1.5%

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies}	Input capacitance		-	2510	-	рF
C _{oes}	Output capacitance	V _{CE} = 25 V, f = 1 MHz, V _{GE} =0	-	175	-	рF
C _{res}	Reverse transfer capacitance		-	30	-	pF
Qg	Total gate charge	V _{CE} = 960 V, I _C = 20 A,V _{GE} =15 V	-	110	-	nC
Q _{ge}	Gate-emitter charge		-	16	-	nC
Q _{gc}	Gate-collector charge		-	49	-	nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{CC} = 960 \text{ V}, I_{C} = 20 \text{ A}$	-	29	-	ns
t _r	Current rise time	R_{G} = 10 Ω , V_{GE} = 15 V,	-	11	-	ns
(di/dt)on	Turn-on current slope	Figure 17	-	1820	-	A/μs
t _{d(on)}	Turn-on delay time	$V_{CC} = 960 \text{ V}, I_{C} = 20 \text{ A}$	-	27	-	ns
t _r	Current rise time	R_G = 10 Ω, V_{GE} = 15 V, T_j =125 °C <i>Figure 17</i>	-	14	-	ns
(di/dt)on	Turn-on current slope		-	1580	-	A/μs
t _{r(Voff)}	Off voltage rise time	V _{CC} = 960 V, I _C = 20 A	-	90	-	ns
t _{d(off)}	Turn-off delay time	R_{G} = 10 Ω , V_{GE} = 15 V, Figure 17	-	275	-	ns
t _f	Current fall time		-	312	-	ns
t _{r(Voff)}	Off voltage rise time	$V_{CC} = 960 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$	-	150	-	ns
t _{d(off)}	Turn-off delay time		-	336	-	ns
t _f	Current fall time	T _j =125 °C <i>Figure 17</i>	-	592	-	ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Eon (1)	Turn-on switching losses	V _{CC} = 960 V, I _C = 20 A	-	1660	-	μ J
E _{off} (2)	Turn-off switching losses	R_G = 10 Ω , V_{GE} = 15 V ,		4438		μJ
E _{ts}	Total switching losses	Figure 17		6098		μJ
Eon (1)	Turn-on switching losses	$V_{CC} = 960 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$	-	3015	-	μ J
E _{off} (2)	Turn-off switching losses		-	6900	-	μ J
E _{ts}	Total switching losses	T _j =125 °C <i>Figure 17</i>	-	9915	-	μJ

Eon is the turn-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25 °C and 125 °C)

Table 8. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
VF	Forward on-voltage	I _F = 20 A	_	1.9	2.5	V
v _F Forward on-voltage		I _F = 20 A, T _C = 125 °C	-	1.7		V
t _{rr}	Reverse recovery time	I _F = 20 A, V _B = 27 V,	-	152	-	ns
Q _{rr}	Reverse recovery charge	$T_j = 125 ^{\circ}\text{C}$, di/dt = 100 A/ μ s	-	722	-	nC
I _{rrm}	Reverse recovery current	Figure 20	-	9	-	Α



^{2.} Turn-off losses include also the tail of the collector current

Electrical characteristics STGW35NC120HD

2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

Figure 3. Transfer characteristics

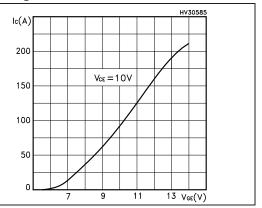
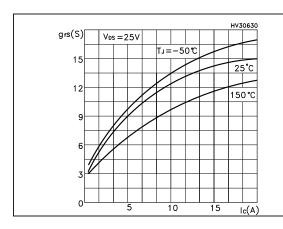


Figure 4. Transconductance

Figure 5. Collector-emitter on voltage vs. temperature



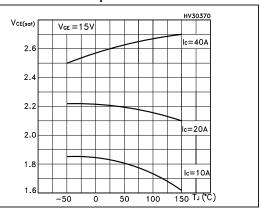
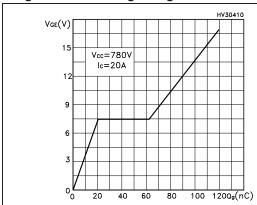


Figure 6. Gate charge vs. gate-source voltage



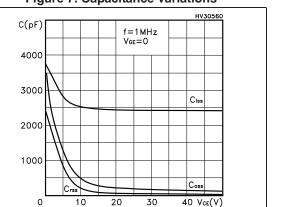
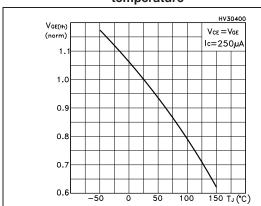


Figure 7. Capacitance variations

577

Figure 8. Normalized gate threshold voltage vs. temperature

Figure 9. Collector-emitter on voltage vs. collector current



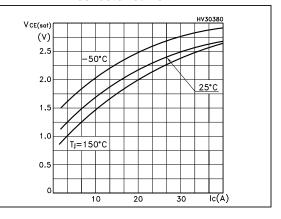
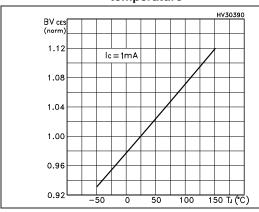


Figure 10. Normalized breakdown voltage vs. temperature

Figure 11. Switching losses vs. temperature



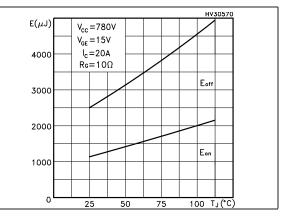
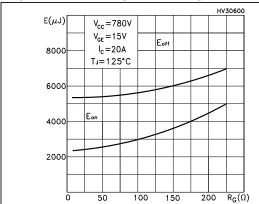
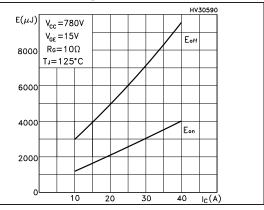


Figure 12. Switching losses vs. gate resistance Figure 13. Switching losses vs. collector current



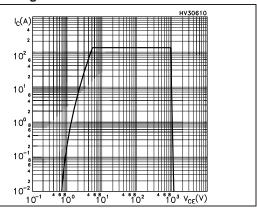


Electrical characteristics STGW35NC120HD

Figure 14. Thermal Impedance

10 SINGLE PULSE

Figure 15. Reverse biased SOA

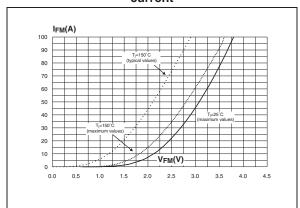


10-3 Figure 16. Forward voltage drop vs. forward current

10-2

 $10^{-1} t_p(s)$

10



STGW35NC120HD Test circuits

3 Test circuits

Figure 17. Test circuit for inductive load switching

Figure 18. Gate charge test circuit

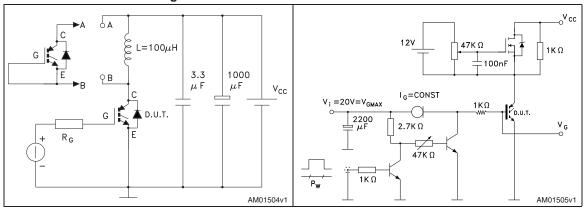
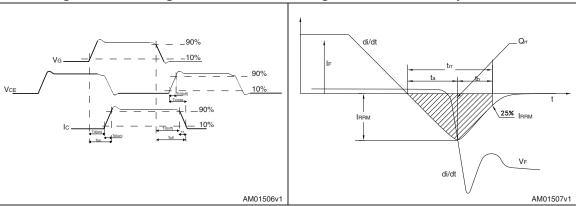


Figure 19. Switching waveform

Figure 20. Diode recovery time waveform



4 Package mechanical data

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Table 9. TO-247 long leads mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.90		5.15
D	1.85		2.10
Е	0.55		0.67
F	1.07		1.32
F1	1.90		2.38
F2	2.87		3.38
G		10.90 BSC	•
Н	15.77		16.02
L	20.82		21.07
L1	4.16		4.47
L2	5.49		5.74
L3	20.05		20.30
L4	3.68		3.93
L5	6.04		6.29
М	2.25		2.55
V		10°	
V1		3°	
V3		20°	
Dia.	3.55		3.66

HEAT-SINK PLANE -DF2 BACK VIEW 7395426_G

Figure 21. TO-247 long leads drawing

Revision history STGW35NC120HD

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
25-Jan-2008	1	First issue.
07-May-2009 2		Section 4: Package mechanical data has been updated.
12-Dec-2013 3		Updated Section 4: Package mechanical data. Minor text changes.

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